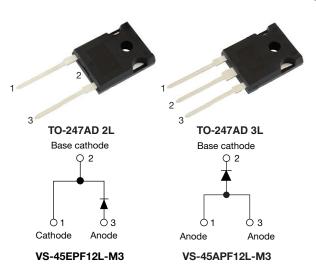


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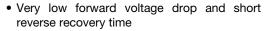
Vishay Semiconductors

Fast Soft Recovery Rectifier Diode, 45 A



PRIMARY CHARACTERISTICS				
I _{F(AV)}	45 A			
V_{R}	1200 V			
V _F at I _F	1.44 V			
I _{FSM}	550 A			
t _{rr}	95 ns			
T _J max.	150 °C			
Snap factor	0.5			
Package	TO-247AD 2L, TO-247AD 3L			
Circuit configuration	Single			

FEATURES





- · Glass passivated pellet chip junction
- Designed and qualified according to JEDEC® - JESD 47
- Flexible solution for reliable AC power rectification
- High surge, low V_F rugged blocking diode for DC charging stations
- AEC-Q101 qualified P/N available (VS-45EPF12LHM3, VS-45APF12LHM3)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

These devices are intended for use in output rectification and freewheeling in inverters, choppers and converters as well as in input rectification where severe restrictions on conducted EMI should be met.

DESCRIPTION

The VS-45EPF12L-M3, VS-45APF12L-M3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	VALUES	UNITS		
I _{F(AV)}	Sinusoidal waveform	45	A		
V _{RRM}		1200	V		
I _{FSM}		550	A		
V _F	20 A, T _J = 25 °C	1.22	V		
t _{rr}	1 A, 100 A/μs	95	ns		
T _J		-40 to +150	°C		

VOLTAGE RATINGS						
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA			
VS-45EPF12L-M3	1200	1300	10			
VS-45APF12L-M3	1200	1300	10			

VS-45EPF12L-M3, VS-45APF12L-M3

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum average forward current	I _{F(AV)}	T _C = 97 °C, 180° conduction half sine wave	45			
Maximum peak one cycle non-repetitive surge current	I _{FSM}	10 ms sine pulse, rated V _{RRM} applied	462	Α		
		10 ms sine pulse, no voltage reapplied	550			
Maximum 12t for fusing	I ² t	10 ms sine pulse, rated V _{RRM} applied	1069	A2a		
Maximum I ² t for fusing	1-1	10 ms sine pulse, no voltage reapplied	1513	- A ² s		
Maximum I ² √t for fusing	I ² √t	t = 0.1 ms to 10 ms, no voltage reapplied	15 125	A ² √s		

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CON	IDITIONS	VALUES	UNITS
Maximum forward voltage drop	V _{FM}	45 A, T _J = 25 °C		1.44	V
Forward slope resistance	r _t	T _J = 150 °C		6.82	mΩ
Threshold voltage	V _{F(TO)}			0.94	V
Maximum rayaraa laakaga ayurrant	1	T _J = 25 °C	\/ - rotod \/	0.1	mA
Maximum reverse leakage current	I _{RM}	T _J = 150 °C	V_R = rated V_{RRM}	10	MA

RECOVERY CHARACTERISTICS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	· •
Reverse recovery time	t _{rr}	I⊏ at 40 A _{ak}	450	ns	I _{FM} t
Reverse recovery current	I _{rr}	I _F at 40 A _{pk} 25 A/µs	6	Α	$t_a \mid t_b$
Reverse recovery charge	Q _{rr}	25 °C	1.8	μC	dir/ dt Q _{rr}
Snap factor	S	Typical	0.5		I _{RM(REC)}

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and s temperature range	torage	T _J , T _{Stg}		-40 to +150	°C
Maximum thermal resistance, unction to case		R_{thJC}	DC operation	0.4	
Maximum thermal resistance, junction to ambient		R _{thJA}		40	°C/W
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth, and greased	0.25	
Approximate weight				6	g
Approximate weight				0.21	OZ.
Mounting torque	Manusting to the second minimum			6 (5)	kgf ⋅ cm
Mounting torque maximu				12 (10)	(lbf ⋅ in)
Madisadais			Case style TO-247AD 2L 45EPF12l		F12L
Marking device			Case style TO-247AD 3L 45APF12L		F12L



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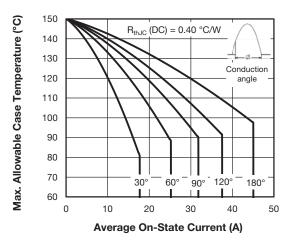


Fig. 1 - Current Rating Characteristics

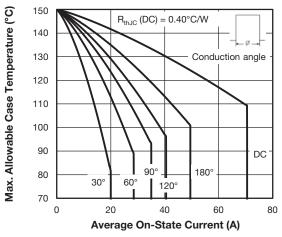


Fig. 2 - Current Rating Characteristics

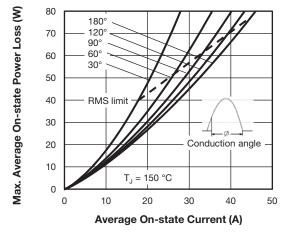


Fig. 3 - Forward Power Loss Characteristics

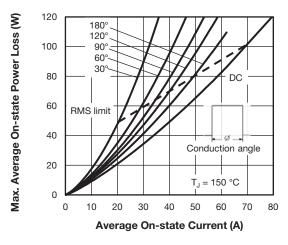


Fig. 4 - Forward Power Loss Characteristics

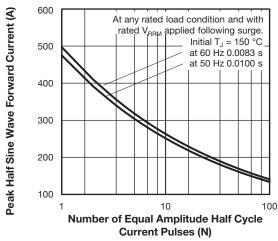


Fig. 5 - Maximum Non-Repetitive Surge Current

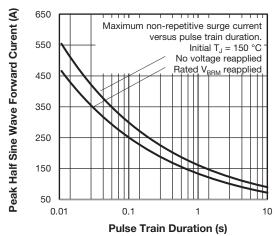


Fig. 6 - Maximum Non-Repetitive Surge Current



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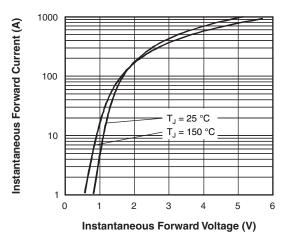


Fig. 7 - Forward Voltage Drop Characteristics

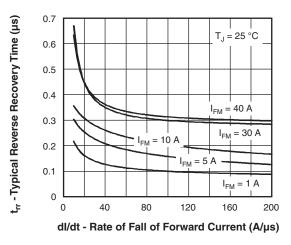


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

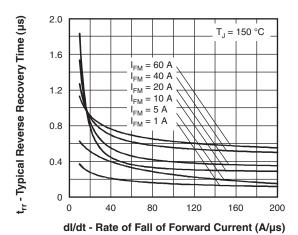


Fig. 9 - Recovery Time Characteristics, $T_J = 150 \, ^{\circ}\text{C}$

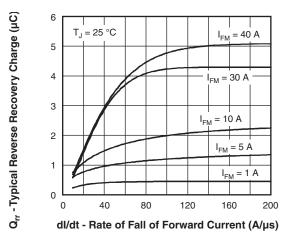


Fig. 10 - Recovery Charge Characteristics, T_J = 25 °C

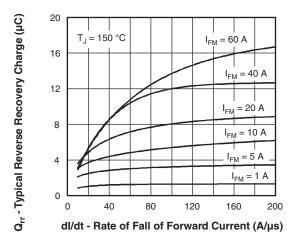


Fig. 11 - Recovery Charge Characteristics, T_J = 150 °C

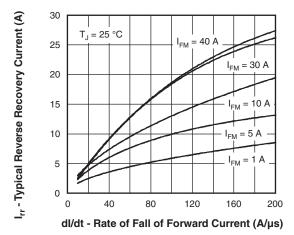


Fig. 12 - Recovery Current Characteristics, $T_J = 25~^{\circ}\text{C}$

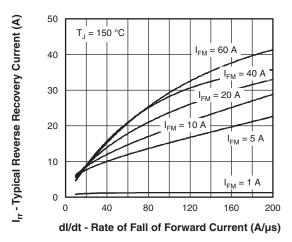


Fig. 13 - Recovery Current Characteristics, T_J = 150 °C

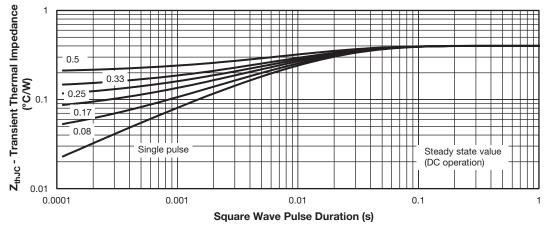


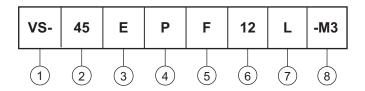
Fig. 14 - Thermal Impedance Z_{thJC} Characteristics

VS-45EPF12L-M3, VS-45APF12L-M3

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (45 = 45 A)

3 - Circuit configuration:

E = single, 2 pins

A = single, 3 pins

4 - Package:

P = TO-247AD

5 - Type of silicon:

F = fast recovery rectifier

6 - Voltage code x 100 = V_{RRM} ______ 12 = 1200 V

7 - L = long leads

8 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-45EPF12L-M3	25	500	Antistatic plastic tubes		
VS-45APF12L-M3	25	500	Antistatic plastic tubes		

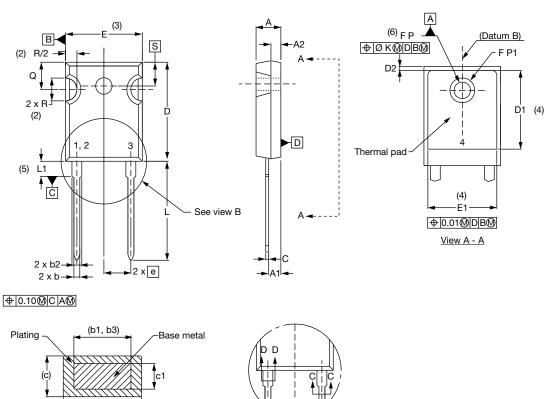
LINKS TO RELATED DOCUMENTS			
Dimensions	TO-247AD 2L	www.vishay.com/doc?95536	
Dimensions	TO-247AD 3L	www.vishay.com/doc?95626	
Port marking information	TO-247AD 2L	www.vishay.com/doc?95648	
Part marking information -	TO-247AD 3L	www.vishay.com/doc?95007	



Vishay Semiconductors

TO-247AD 2L

DIMENSIONS in millimeters and inches



View B

SYMBOL	MILLIMETERS INCHES		NOTES		
STIVIDUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4
D2	0.51	1.35	0.020	0.053	

Section C - C, D - D

SYMBOL	MILLIN	MILLIMETERS		INCHES		
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Е	15.29	15.87	0.602	0.625	3	
E1	13.46	-	0.53	-		
е	5.46	BSC	0.215	BSC		
ØK	0.254		0.0	10		
L	19.81	20.32	0.780	0.800		
L1	3.71	4.29	0.146	0.169		
ØΡ	3.56	3.66	0.14	0.144		
Ø P1	-	6.98	-	0.275		
Q	5.31	5.69	0.209	0.224		
R	4.52	5.49	0.178	0.216		
S	5.51 BSC		0.217	BSC		
	•		•	•		

Notes

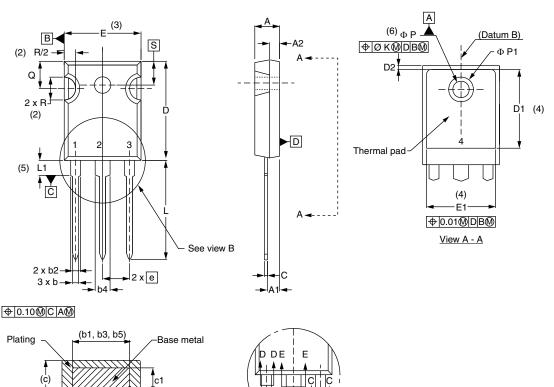
- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



Vishay Semiconductors

TO-247AD 3L

DIMENSIONS in millimeters and inches



View B

Section C - C, D - D, E - E						
SYMBOL	MILLIN	IETERS	INC	NOTES		
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.65	5.31	0.183	0.209		
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• •			0.050			

SYMBOL	MILLIMILILIA		INOTIES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46 BSC		0.215 BSC		
ØΚ	0.254		0.010		
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		
		<u> </u>	<u> </u>	<u> </u>	

Notes

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- (2) Contour of slot optional
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